

## P-Channel Enhancement-Mode MOSFET Transistor

### Product Summary

V <sub>(BR)DSS</sub> Min (V)	r <sub>D(on)</sub> Max (Ω)	V <sub>GS(th)</sub> (V)	I <sub>D</sub> (A)
-60	5 @ V <sub>GS</sub> = -10 V	-2 to -4.5	-0.41

### Features

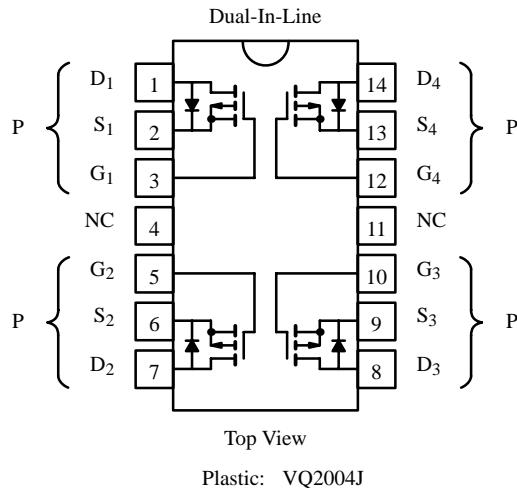
- High-Side Switching
- Low On-Resistance: 2.5 Ω
- Moderate Threshold: -3.4 V
- Fast Switching Speed: 40 ns
- Low Input Capacitance: 75 pF

### Benefits

- Ease in Driving Switches
- Low Offset (Error) Voltage
- Low-Voltage Operation
- High-Speed Switching
- Easily Driven Without Buffer

### Applications

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Battery Operated Systems
- Power Supply, Converter Circuits
- Motor Control



### Absolute Maximum Ratings (T<sub>A</sub> = 25°C Unless Otherwise Noted)

Parameter	Symbol	Single	Total Quad	Unit
Drain-Source Voltage	V <sub>DS</sub>	-60		V
Gate-Source Voltage	V <sub>GS</sub>	±30		
Continuous Drain Current (T <sub>J</sub> = 150°C)	I <sub>D</sub>	-0.41		A
		-0.23		
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	-3		
Power Dissipation	P <sub>D</sub>	1.3	2	W
		0.52	0.8	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	96	62.5	°C/W
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150		°C

Notes

a. Pulse width limited by maximum junction temperature.

Updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #70220.

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## Specifications<sup>a</sup>

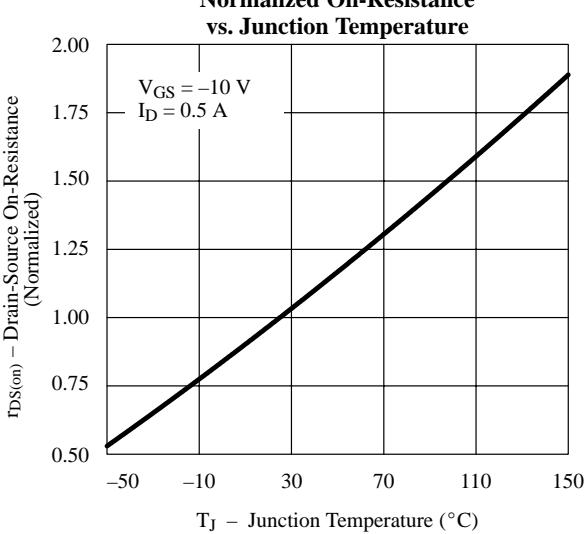
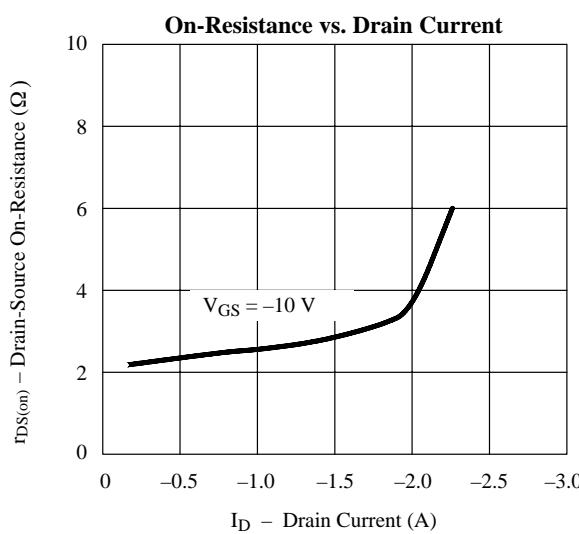
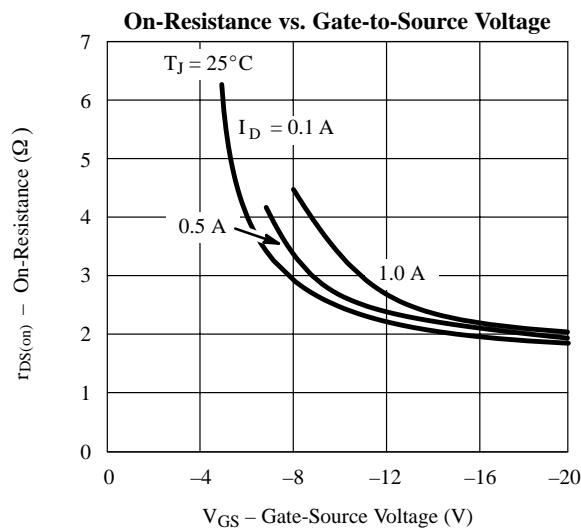
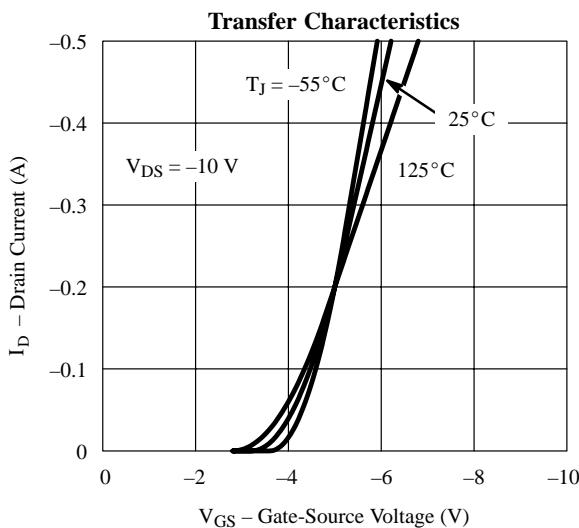
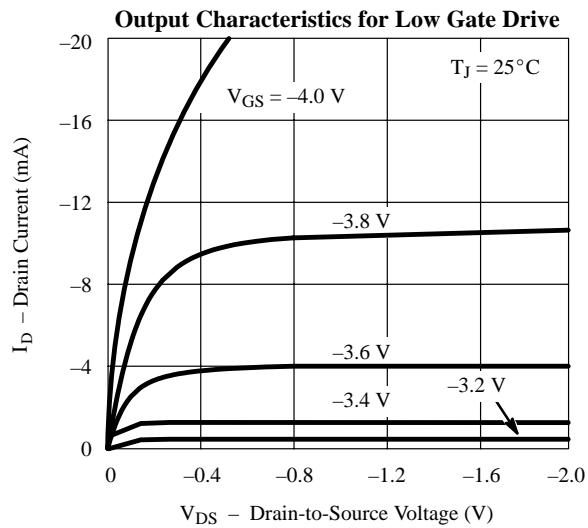
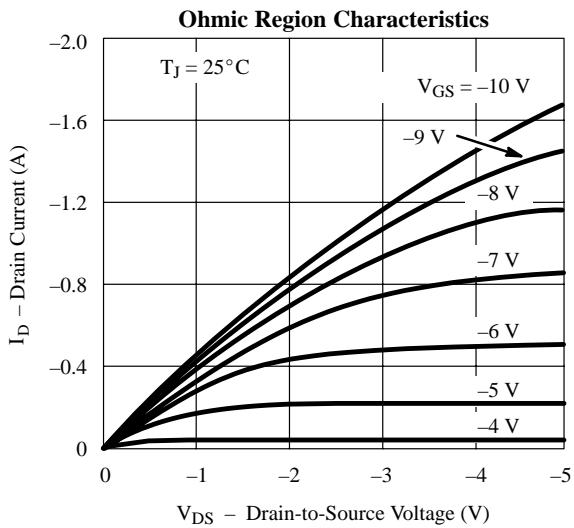
Parameter	Symbol	Test Conditions	Limits			Unit
			Min	Typ <sup>b</sup>	Max	
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -10 µA	-60	-110		V
Gate-Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -1 mA	-2	-3.4	-4.5	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 30 V T <sub>J</sub> = 125°C			± 100 ± 500	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -60 V, V <sub>GS</sub> = 0 V			-10	µA
		V <sub>DS</sub> = -48 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125°C			-500	
On-State Drain Current <sup>c</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = -10 V	-1	-2		A
Drain-Source On-Resistance <sup>c</sup>	r <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -1 A T <sub>J</sub> = 125°C		2.5	5	Ω
				4.4	8	
Forward Transconductance <sup>c</sup>	g <sub>f</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -0.5 A	200	325		mS
Common Source Output Conductance <sup>c</sup>	g <sub>os</sub>	V <sub>DS</sub> = -7.5 V, I <sub>D</sub> = -0.1 A		0.45		
<b>Dynamic</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -25 V, V <sub>GS</sub> = 0 V f = 1 MHz		75	150	pF
Output Capacitance	C <sub>oss</sub>			40	60	
Reverse Transfer Capacitance	C <sub>rss</sub>			18	25	
<b>Switching<sup>d</sup></b>						
Turn-On Time	t <sub>d(on)</sub>	V <sub>DD</sub> = -25 V, R <sub>L</sub> = 47 Ω I <sub>D</sub> ≈ -0.5 A, V <sub>GEN</sub> = -10 V R <sub>G</sub> = 25 Ω		11	15	ns
	t <sub>r</sub>			30	40	
Turn-Off Time	t <sub>d(off)</sub>			20	30	
	t <sub>f</sub>			20	30	

Notes

- a. T<sub>A</sub> = 25°C unless otherwise noted.
- b. For DESIGN AID ONLY, not subject to production testing.
- c. Pulse test: PW ≤ 300 µs duty cycle ≤ 2%.
- d. Switching time is essentially independent of operating temperature.

VPDV10

## Typical Characteristics (25°C Unless Otherwise Noted)



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## Typical Characteristics (25°C Unless Otherwise Noted) (Cont'd)

